MA342-B, MA342-M

Silicon epitaxial planer type

For UHF and VHF electronic tuners AFC

■ Features

- Large capacity variation ratio
- Small series resistance r_D

■ Absolute Maximum Ratings (Ta= 25°C)

Parameter	Symbol	Rating	Unit
Reverse voltage (DC)	V _R	32	V
Peak reverse voltage	V _{RM} *	34	V
Junction temperature	T_{j}	150	°C
Storage temperature	T _{stg}	- 55 to +150	°C

^{*} R_L = 2.2 $k\Omega$, 1 pulse

■ Electrical Characteristics (Ta= 25°C)

Parameter	Symbol	Condition	min	typ	max	Unit
Forward voltage (DC)	$V_{\rm F}$	I _F =100mA			1.1	V
Reverse current (DC)	I_R	$V_R = 30V$			10	nA
Terminal capacitance		$V_R = 2V$, $f = 1MHz$	10.5		16	nE
	$C_{\rm t}$	V _R =10V, f=1MHz	3.3		5.7	pF
Capacitance ratio	$C_{t(2V)}/C_{t(10V)}^*$	2,1100	2.8		3.4	_
	$C_{t(6V)}/C_{t(10V)}$	~o.i//	1.64			_
Series resistance	$r_{\rm D}$	C _D = 9pF, f= 470MHz			1.2	Ω

Note 1. Rated input/output frequency: 470MHz

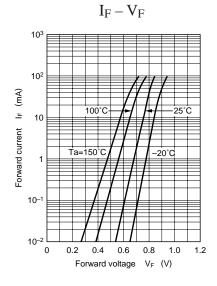
■ Cathode Indication

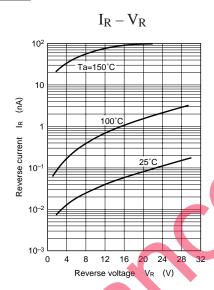
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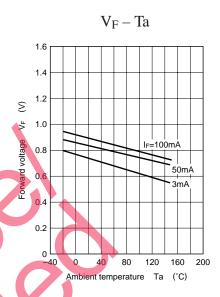
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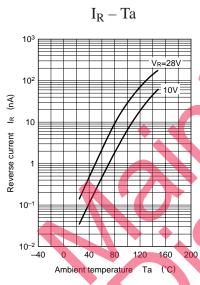
^{2. *} Applicable to the rank M

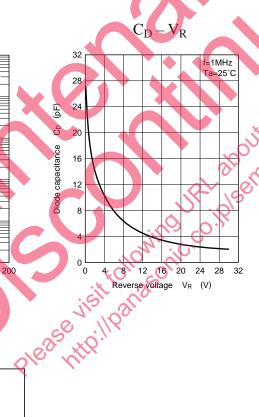
Characteristics chart of MA342-B



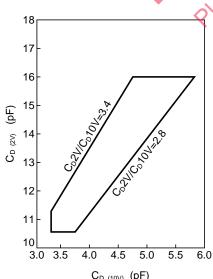




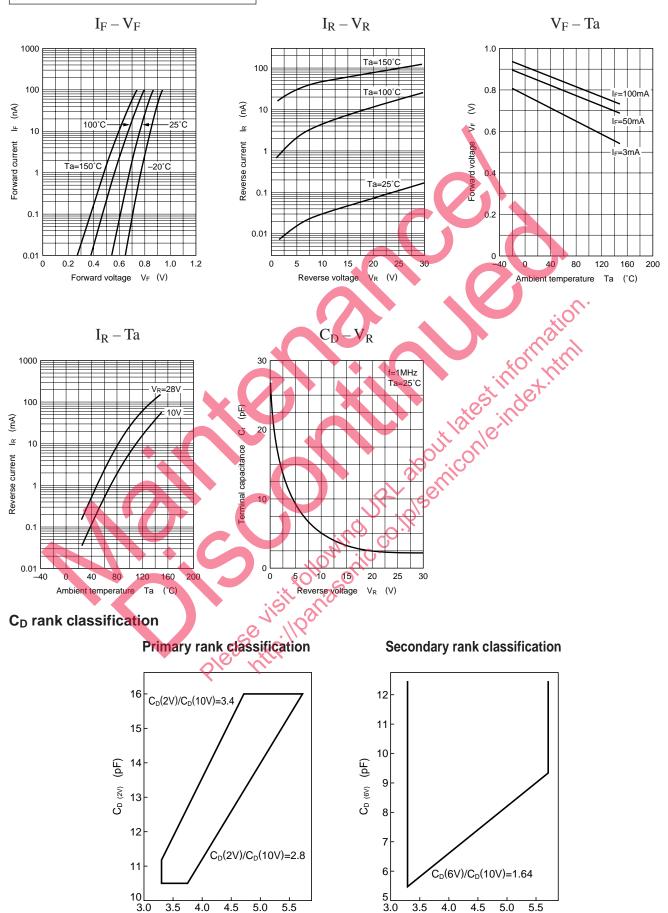




C_D rank classification



Characteristics chart of MA342-M



Panasonic

 $C_{D\ (10V)}\ (pF)$

C_{D (10V)} (pF)

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